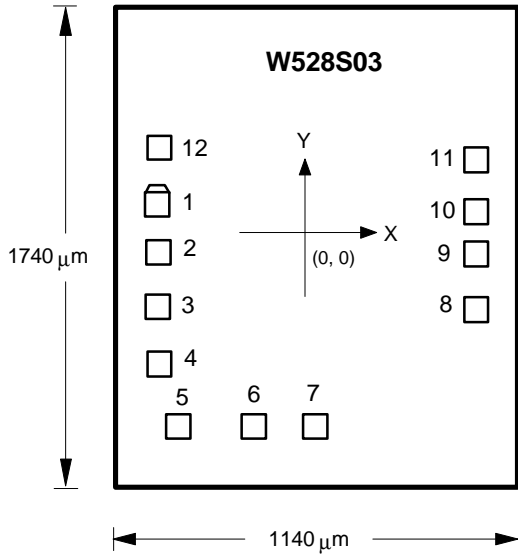


W528S03 Bonding Pad Diagram



PAD NO.	PAD NAME	X (μm)	Y (μm)
1	TG1	-406.00	61.40
2	TG2	-406.00	-116.60
3	TG3	-406.00	-318.60
4	TG4/LED2 /STPC	-406.00	-548.00
5	LED1	-346.00	-709.00
6	STPB	-114.00	-709.00
7	STPA	86.00	-709.00
8	SPK	398.16	-299.64
9	VSS	398.16	-99.64
10	VDD	398.16	27.36
11	OSC	398.16	212.36
12	TEST	-406.00	263.40

Note : Substrate is tied to VSS.